## HW#3

## (Submit to bCourses by 11 pm on 2/15)

- 1) For a *p*-type silicon in which the dopant concentration  $N_A = 5 \times 10^{18} / \text{cm}^3$ , find the hole and electron concentrations at T = 300 K.
- 2) Find the current that flows in a silicon bar of 10 µm length having a 5 µm × 4 µm crosssection and having free-electron and hole densities of  $10^4/\text{cm}^3$  and  $10^{16}/\text{cm}^3$ , respectively, when a 1 V is applied end-to-end. Use  $\mu_n = 1200 \text{ cm}^2/\text{V} \cdot \text{s}$  and  $\mu_p = 500 \text{cm}^2/\text{V} \cdot \text{s}$ .
- 3) Holes are being steadily injected into a region of *n*-type silicon (connected to other devices, the details of which are not importation for this question). In the steady state, the excess-hole concentration profile show in the following figure is established in the *n*-type silicon region. Here "excess" means over and above the thermal-equilibrium concentration (in the absence of hole injection), denoted  $p_{n0}$ . If  $N_D = 10^{16}/\text{cm}^3$ ,  $n_i = 1.5 \times 10^{10}/\text{cm}^3$ ,  $D_p = 12 \text{ cm}^2/\text{s}$ , and W = 50 nm, find the density of the current that will flow in the *x* direction.



4) Calculate the built-in voltage of a junction in which the *p* and *n* regions are doped equally with  $5 \times 10^{16}$  atoms/cm<sup>3</sup>. Assume  $n_i = 1.5 \times 10^{10}$ /cm<sup>3</sup>. With the terminals left open, what is the width of the depletion region, and how far does it extend into the *p* and *n* regions? If the cross-sectional area of the junction is 20 µm<sup>2</sup>, find the magnitude of the charge stored on either side of the junction.